

# FDS8958A

## Dual N & P-Channel PowerTrench® MOSFET

### General Description

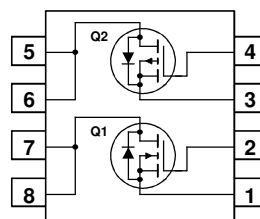
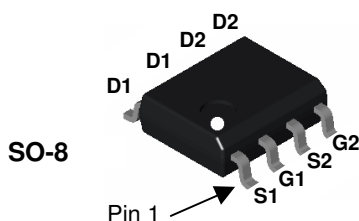
These dual N- and P-Channel enhancement mode power field effect transistors are produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize on-state resistance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.



### Features

- **Q1:** N-Channel  
7.0A, 30V  $R_{DS(on)} = 0.028\Omega @ V_{GS} = 10V$   
 $R_{DS(on)} = 0.040\Omega @ V_{GS} = 4.5V$
- **Q2:** P-Channel  
-5A, -30V  $R_{DS(on)} = 0.052\Omega @ V_{GS} = -10V$   
 $R_{DS(on)} = 0.080\Omega @ V_{GS} = -4.5V$
- Fast switching speed
- High power and handling capability in a widely used surface mount package



### Absolute Maximum Ratings $T_A = 25^\circ\text{C}$ unless otherwise noted

| Symbol         | Parameter                                        | Q1          | Q2       | Units            |
|----------------|--------------------------------------------------|-------------|----------|------------------|
| $V_{DS}$       | Drain-Source Voltage                             | 30          | 30       | V                |
| $V_{GS}$       | Gate-Source Voltage                              | $\pm 20$    | $\pm 20$ | V                |
| $I_D$          | Drain Current - Continuous (Note 1a)             | 7           | -5       | A                |
|                | - Pulsed                                         | 20          | -20      |                  |
| $P_D$          | Power Dissipation for Dual Operation             | 2           | 2        | W                |
|                | Power Dissipation for Single Operation (Note 1a) | 1.6         | 1.6      |                  |
|                | (Note 1c)                                        | 0.9         | 0.9      |                  |
| $E_{AS}$       | Single Pulse Avalanche Energy (Note 3)           | 54          | 13       | mJ               |
| $T_J, T_{STG}$ | Operating and Storage Junction Temperature Range | -55 to +150 |          | $^\circ\text{C}$ |

### Thermal Characteristics

|                 |                                                   |    |                    |
|-----------------|---------------------------------------------------|----|--------------------|
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient (Note 1a) | 78 | $^\circ\text{C/W}$ |
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case (Note 1)     | 40 | $^\circ\text{C/W}$ |

### Package Marking and Ordering Information

| Device Marking | Device   | Reel Size | Tape width | Quantity   |
|----------------|----------|-----------|------------|------------|
| FDS8958A       | FDS8958A | 13"       | 12mm       | 2500 units |

**Electrical Characteristics** $T_A = 25^\circ\text{C}$  unless otherwise noted

| Symbol                               | Parameter                                 | Test Conditions                                                                                                                         | Type     | Min       | Typ       | Max     | Units                |
|--------------------------------------|-------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------|----------|-----------|-----------|---------|----------------------|
| <b>Off Characteristics</b>           |                                           |                                                                                                                                         |          |           |           |         |                      |
| $BV_{DSS}$                           | Drain-Source Breakdown Voltage            | $V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$<br>$V_{GS} = 0\text{ V}, I_D = -250\text{ }\mu\text{A}$                             | Q1<br>Q2 | 30<br>-30 |           |         | V                    |
| $\frac{\Delta BV_{DSS}}{\Delta T_J}$ | Breakdown Voltage Temperature Coefficient | $I_D = 250\text{ }\mu\text{A}$ , Referenced to $25^\circ\text{C}$<br>$I_D = -250\text{ }\mu\text{A}$ , Referenced to $25^\circ\text{C}$ | Q1<br>Q2 |           | 25<br>-23 |         | mV/ $^\circ\text{C}$ |
| $I_{DSS}$                            | Zero Gate Voltage Drain Current           | $V_{DS} = 24\text{ V}, V_{GS} = 0\text{ V}$<br>$V_{DS} = -24\text{ V}, V_{GS} = 0\text{ V}$                                             | Q1<br>Q2 |           |           | 1<br>-1 | $\mu\text{A}$        |
| $I_{GSSF}$                           | Gate-Body Leakage, Forward                | $V_{GS} = 20\text{ V}, V_{DS} = 0\text{ V}$                                                                                             | All      |           |           | 100     | nA                   |
| $I_{GSSR}$                           | Gate-Body Leakage, Reverse                | $V_{GS} = -20\text{ V}, V_{DS} = 0\text{ V}$                                                                                            | All      |           |           | -100    | nA                   |

**On Characteristics** (Note 2)

|                                        |                                                |                                                                                                                                                                                                                                                                                                                                |                  |           |                                  |                                  |                      |
|----------------------------------------|------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|-----------|----------------------------------|----------------------------------|----------------------|
| $V_{GS(th)}$                           | Gate Threshold Voltage                         | $V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$<br>$V_{DS} = V_{GS}, I_D = -250\text{ }\mu\text{A}$                                                                                                                                                                                                                            | Q1<br>Q2         | 1<br>-1   | 1.9<br>-1.7                      | 3<br>-3                          | V                    |
| $\frac{\Delta V_{GS(th)}}{\Delta T_J}$ | Gate Threshold Voltage Temperature Coefficient | $I_D = 250\text{ }\mu\text{A}$ , Referenced to $25^\circ\text{C}$<br>$I_D = -250\text{ }\mu\text{A}$ , Referenced to $25^\circ\text{C}$                                                                                                                                                                                        | Q1<br>Q2         |           | -4.5<br>4.5                      |                                  | mV/ $^\circ\text{C}$ |
| $R_{DS(on)}$                           | Static Drain-Source On-Resistance              | $V_{GS} = 10\text{ V}, I_D = 7\text{ A}$<br>$V_{GS} = 10\text{ V}, I_D = 7\text{ A}, T_J = 125^\circ\text{C}$<br>$V_{GS} = 4.5\text{ V}, I_D = 6\text{ A}$<br>$V_{GS} = -10\text{ V}, I_D = -5\text{ A}$<br>$V_{GS} = -10\text{ V}, I_D = -5\text{ A}, T_J = 125^\circ\text{C}$<br>$V_{GS} = -4.5\text{ V}, I_D = -4\text{ A}$ | Q1<br><br><br>Q2 |           | 19<br>27<br>24<br>42<br>57<br>65 | 28<br>42<br>40<br>52<br>78<br>80 | $\text{m}\Omega$     |
| $I_{D(on)}$                            | On-State Drain Current                         | $V_{GS} = 10\text{ V}, V_{DS} = 5\text{ V}$<br>$V_{GS} = -10\text{ V}, V_{DS} = -5\text{ V}$                                                                                                                                                                                                                                   | Q1<br>Q2         | 20<br>-20 |                                  |                                  | A                    |
| $g_{FS}$                               | Forward Transconductance                       | $V_{DS} = 5\text{ V}, I_D = 7\text{ A}$<br>$V_{DS} = -5\text{ V}, I_D = -5\text{ A}$                                                                                                                                                                                                                                           | Q1<br>Q2         |           | 25<br>10                         |                                  | S                    |

**Dynamic Characteristics**

|           |                              |                                                                        |          |  |            |  |          |
|-----------|------------------------------|------------------------------------------------------------------------|----------|--|------------|--|----------|
| $C_{iss}$ | Input Capacitance            | Q1<br>$V_{DS} = 15\text{ V}, V_{GS} = 0\text{ V}, f = 1.0\text{ MHz}$  | Q1<br>Q2 |  | 575<br>528 |  | pF       |
| $C_{oss}$ | Output Capacitance           | Q2<br>$V_{DS} = -15\text{ V}, V_{GS} = 0\text{ V}, f = 1.0\text{ MHz}$ | Q1<br>Q2 |  | 145<br>132 |  | pF       |
| $C_{rss}$ | Reverse Transfer Capacitance |                                                                        | Q1<br>Q2 |  | 65<br>70   |  | pF       |
| $R_G$     | Gate Resistance              | $V_{GS} = 15\text{ mV}, f = 1.0\text{ MHz}$                            | Q1<br>Q2 |  | 2.1<br>6.0 |  | $\Omega$ |

# Electrical Characteristics (continued)

$T_A = 25^\circ\text{C}$  unless otherwise noted

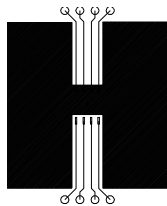
| Symbol                                    | Parameter           | Test Conditions                                                                                          | Type | Min | Typ  | Max | Units |
|-------------------------------------------|---------------------|----------------------------------------------------------------------------------------------------------|------|-----|------|-----|-------|
| <b>Switching Characteristics</b> (Note 2) |                     |                                                                                                          |      |     |      |     |       |
| $t_{d(on)}$                               | Turn-On Delay Time  | Q1<br>$V_{DD} = 15\text{ V}$ , $I_D = 1\text{ A}$ ,<br>$V_{GS} = 10\text{ V}$ , $R_{GEN} = 6\ \Omega$    | Q1   |     | 8    | 16  | ns    |
| $t_r$                                     | Turn-On Rise Time   |                                                                                                          | Q2   |     | 7    | 14  |       |
| $t_{d(off)}$                              | Turn-Off Delay Time | Q2<br>$V_{DD} = -15\text{ V}$ , $I_D = -1\text{ A}$ ,<br>$V_{GS} = -10\text{ V}$ , $R_{GEN} = 6\ \Omega$ | Q1   |     | 5    | 10  | ns    |
| $t_f$                                     | Turn-Off Fall Time  |                                                                                                          | Q2   |     | 13   | 24  |       |
| $Q_g$                                     | Total Gate Charge   | Q1<br>$V_{DS} = 15\text{ V}$ , $I_D = 7\text{ A}$ , $V_{GS} = 10\text{ V}$                               | Q1   |     | 23   | 37  | ns    |
| $Q_{gs}$                                  | Gate-Source Charge  |                                                                                                          | Q2   |     | 14   | 25  |       |
| $Q_{gd}$                                  | Gate-Drain Charge   | Q2<br>$V_{DS} = -15\text{ V}$ , $I_D = -5\text{ A}$ , $V_{GS} = -10\text{ V}$                            | Q1   |     | 3    | 6   | ns    |
|                                           |                     |                                                                                                          | Q2   |     | 9    | 17  |       |
|                                           |                     |                                                                                                          | Q1   |     | 11.4 | 16  | nC    |
|                                           |                     |                                                                                                          | Q2   |     | 9.6  | 13  |       |
|                                           |                     |                                                                                                          | Q1   |     | 1.7  |     | nC    |
|                                           |                     |                                                                                                          | Q2   |     | 2.2  |     |       |
|                                           |                     |                                                                                                          | Q1   |     | 2.1  |     | nC    |
|                                           |                     |                                                                                                          | Q2   |     | 1.7  |     |       |

## Drain-Source Diode Characteristics and Maximum Ratings

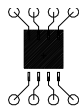
|                 |                                                            |                                                                                                                   |          |               |             |    |
|-----------------|------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------|----------|---------------|-------------|----|
| I <sub>S</sub>  | Maximum Continuous Drain-Source Diode Forward Current      |                                                                                                                   | Q1<br>Q2 |               | 1.3<br>-1.3 | A  |
| I <sub>SM</sub> | Maximum Pulsed Drain-Source Diode Forward Current (Note 2) |                                                                                                                   | Q1<br>Q2 |               | 20<br>-20   | A  |
| V <sub>SD</sub> | Drain-Source Diode Forward Voltage                         | V <sub>GS</sub> = 0 V, I <sub>S</sub> = 1.3 A (Note 2)<br>V <sub>GS</sub> = 0 V, I <sub>S</sub> = -1.3 A (Note 2) | Q1<br>Q2 | 0.75<br>-0.88 | 1.2<br>-1.2 | V  |
| t <sub>rr</sub> | Diode Reverse Recovery Time                                | Q1<br>I <sub>F</sub> = 7 A, d <sub>I<sub>F</sub></sub> /d <sub>t</sub> = 100 A/μs                                 | Q1<br>Q2 | 19<br>19      |             | nS |
| Q <sub>rr</sub> | Diode Reverse Recovery Charge                              | Q2<br>I <sub>F</sub> = -5 A, d <sub>I<sub>F</sub></sub> /d <sub>t</sub> = 100 A/μs                                | Q1<br>Q2 | 9<br>6        |             | nC |

### Notes:

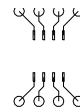
- $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta CA}$  is determined by the user's board design.



a) 78°/W when mounted on a 0.5 in<sup>2</sup> pad of 2 oz copper



b) 125°/W when mounted on a .02 in<sup>2</sup> pad of 2 oz copper



c) 135°/W when mounted on a minimum pad.

Scale 1 : 1 on letter size paper

- Pulse Test: Pulse Width < 300 $\mu\text{s}$ , Duty Cycle < 2.0%
- Starting  $T_J = 25^\circ\text{C}$ ,  $L = 3\text{ mH}$ ,  $I_{AS} = 6\text{ A}$ ,  $V_{DD} = 30\text{ V}$ ,  $V_{GS} = 10\text{ V}$  (Q1).  
Starting  $T_J = 25^\circ\text{C}$ ,  $L = 3\text{ mH}$ ,  $I_{AS} = 3\text{ A}$ ,  $V_{DD} = 30\text{ V}$ ,  $V_{GS} = 10\text{ V}$  (Q2).

## Typical Characteristics: Q1 (N-Channel)

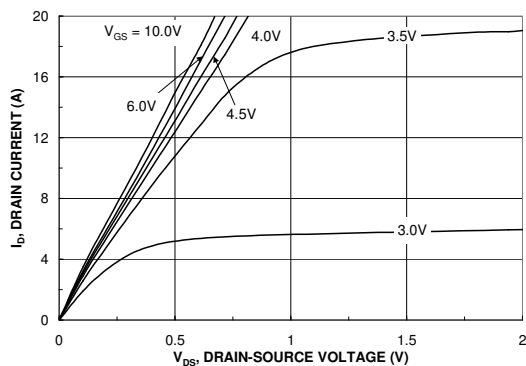


Figure 1. On-Region Characteristics.

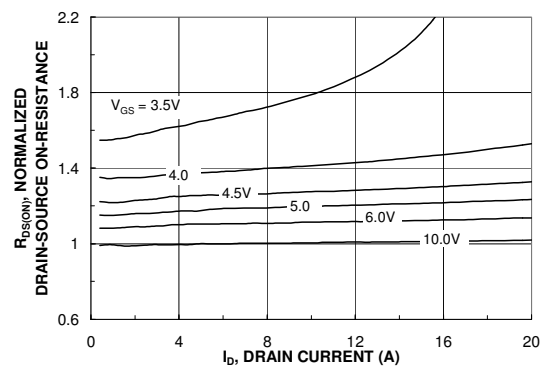


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

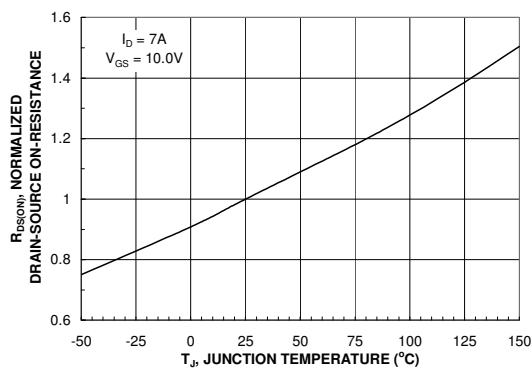


Figure 3. On-Resistance Variation with Temperature.

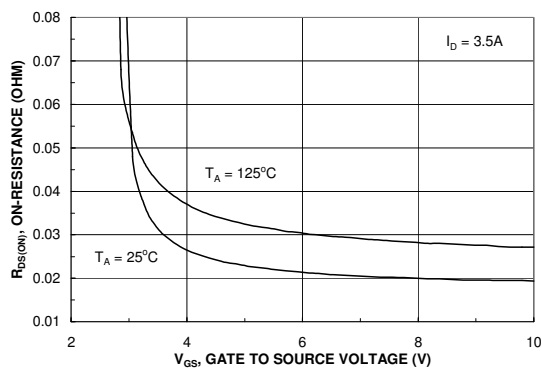


Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

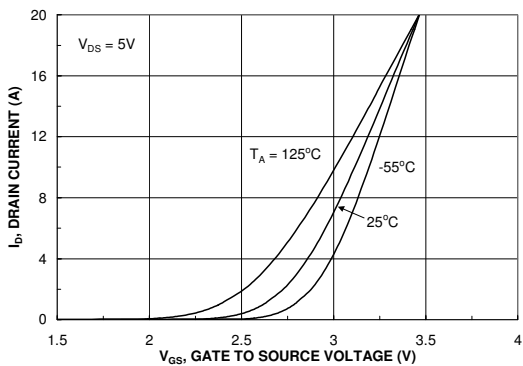


Figure 5. Transfer Characteristics.

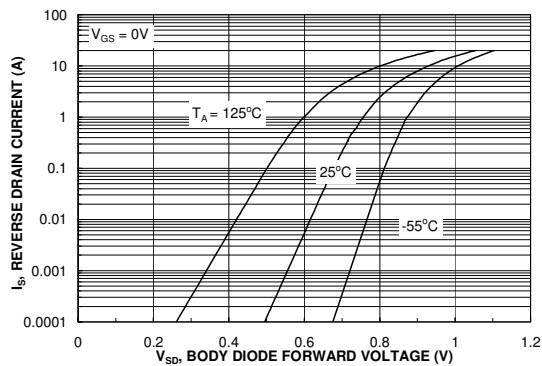


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

## Typical Characteristics: Q1 (N-Channel)

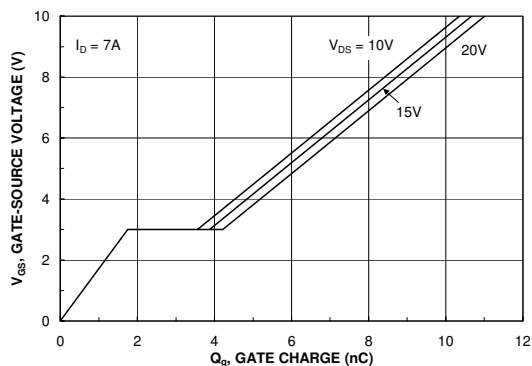


Figure 7. Gate Charge Characteristics.

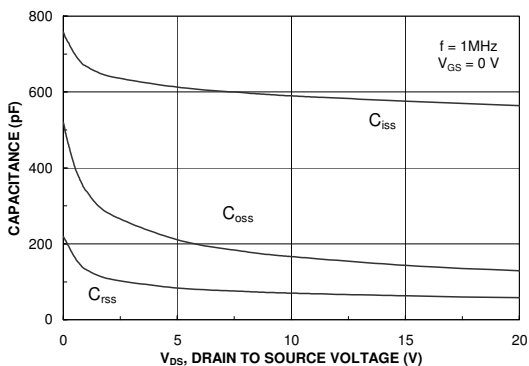


Figure 8. Capacitance Characteristics.

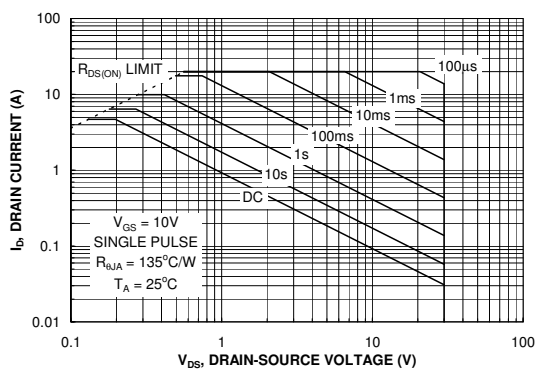


Figure 9. Maximum Safe Operating Area.

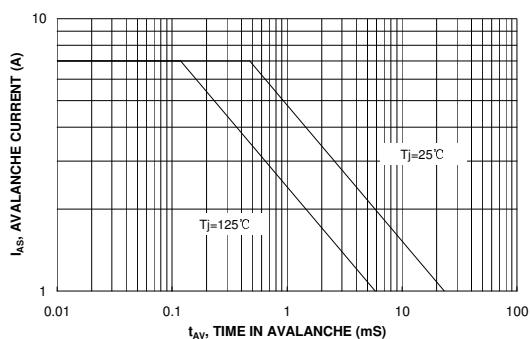


Figure 10. Unclamped Inductive Switching Capability Figure

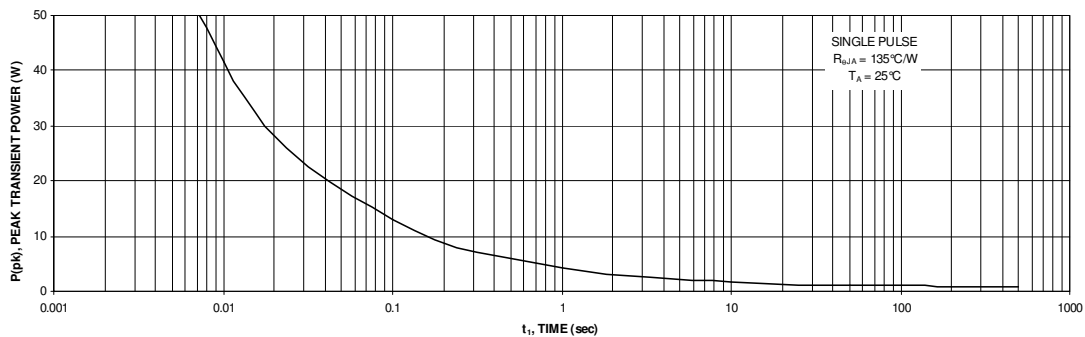


Figure 11. Single Pulse Maximum Power Dissipation.

## Typical Characteristics: Q2 (P-Channel)

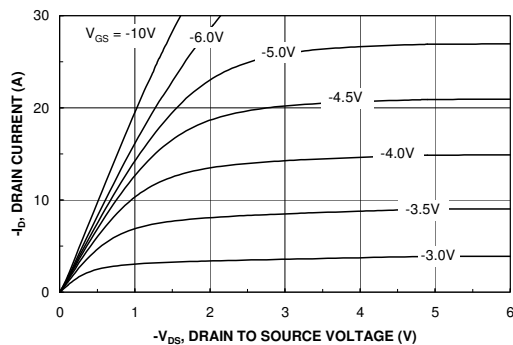


Figure 12. On-Region Characteristics.

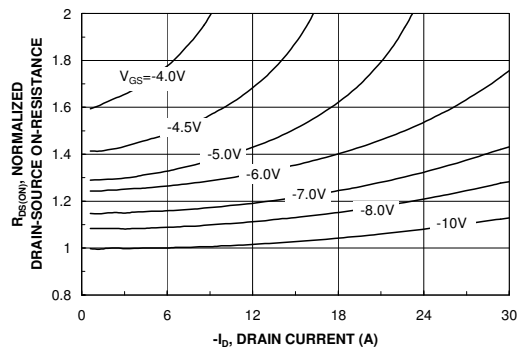


Figure 13. On-Resistance Variation with Drain Current and Gate Voltage.

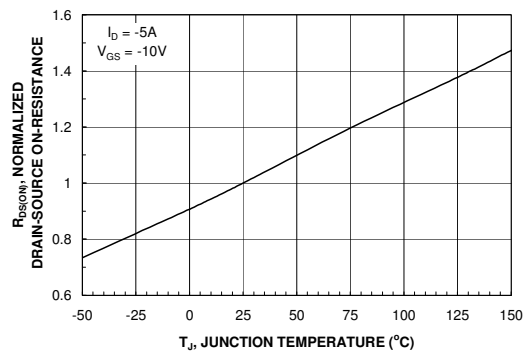


Figure 14. On-Resistance Variation with Temperature.

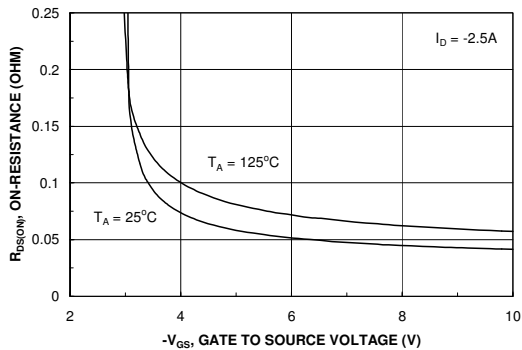


Figure 15. On-Resistance Variation with Gate-to-Source Voltage.

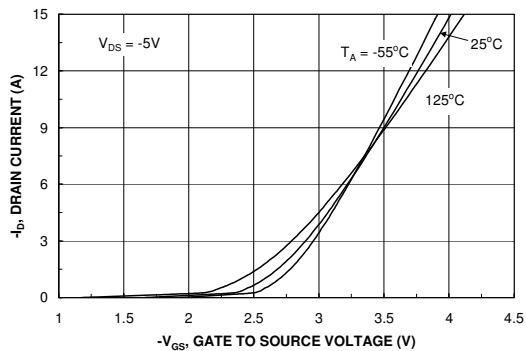


Figure 16. Transfer Characteristics.

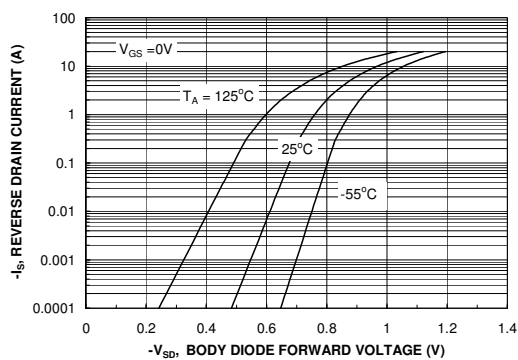
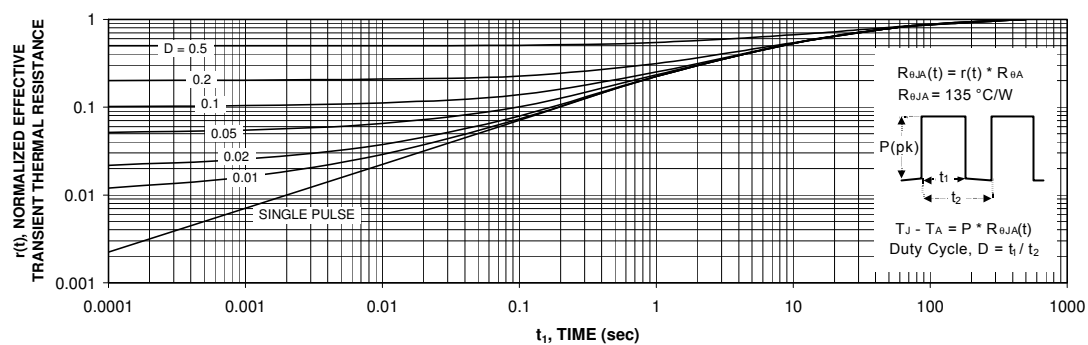


Figure 17. Body Diode Forward Voltage Variation with Source Current and Temperature.

# Typical Characteristics: Q2 (P-Channel)



**Figure 23. Transient Thermal Response Curve.**

Thermal characterization performed using the conditions described in Note 1c.  
Transient thermal response will change depending on the circuit board design.



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| EfficientMax <sup>™</sup>                                                         | ISOPLANAR <sup>™</sup>                                                            | Saving our world 1mW at a time <sup>™</sup>                                       | TinyWire <sup>™</sup>                                                               |
| EZSWITCH <sup>™</sup> *                                                           | MegaBuck <sup>™</sup>                                                             | SmartMax <sup>™</sup>                                                             | μSerDes <sup>™</sup>                                                                |
|  | MICROCOUPLER <sup>™</sup>                                                         | SMART START <sup>™</sup>                                                          |  |
|  | MicroFET <sup>™</sup>                                                             | SPM <sup>®</sup>                                                                  | UHC <sup>®</sup>                                                                    |
| Fairchild <sup>®</sup>                                                            | MicroPak <sup>™</sup>                                                             | STEALTH <sup>™</sup>                                                              | Ultra FRFET <sup>™</sup>                                                            |
| Fairchild Semiconductor <sup>®</sup>                                              | MillerDrive <sup>™</sup>                                                          | SuperFET <sup>™</sup>                                                             | UniFET <sup>™</sup>                                                                 |
| FACT Quiet Series <sup>™</sup>                                                    | MotionMax <sup>™</sup>                                                            | SuperSOT <sup>™</sup> -3                                                          | VCX <sup>™</sup>                                                                    |
| FACT <sup>®</sup>                                                                 | Motion-SPM <sup>™</sup>                                                           | SuperSOT <sup>™</sup> -6                                                          | VisualMax <sup>™</sup>                                                              |
| FAST <sup>®</sup>                                                                 | OPTOLOGIC <sup>®</sup>                                                            | SuperSOT <sup>™</sup> -8                                                          |                                                                                     |
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| FlashWriter <sup>®</sup> *                                                        |  |  |                                                                                     |

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